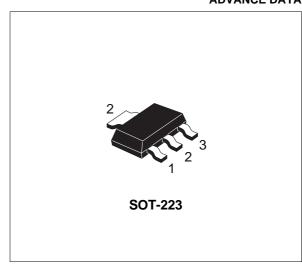


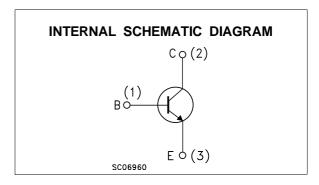
BCP55/56

MEDIUM POWER AMPLIFIER

ADVANCE DATA

- SILICON EPITAXIAL PLANAR NPN TRANSISTORS
- MINIATURE PLASTIC PACKAGE FOR APPLICATION IN SURFACE MOUNTING CIRCUITS
- GENERAL PURPOSE MAINLY INTENDED FOR USE IN MEDIUM POWER INDUSTRIAL APPLICATION AND FOR AUDIO AMPLIFIER OUTPUT STAGE
- PNP COMPLEMENTS ARE BCP52 AND BCP53 RESPECTIVELY





ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Va	Unit	
		BCP55	BCP56	
Vсво	Collector-Base Voltage (I _E = 0)	60	100	V
V _{CEO}	Collector-Emitter Voltage (I _B = 0)	60	80	V
V _{CER}	Collector-Emitter Voltage ($R_{BE} = 1K\Omega$)	60 100		V
V _{EBO}	Emitter-Base Voltage (I _C = 0)	5		V
Ic	Collector Current	1		А
I _{CM}	Collector Peak Current (t _p < 5 ms)	1	А	
I _B	Base Current	0.1		А
I _{BM}	Base Peak Current (tp < ms)	0.2		Α
P _{tot}	Total Dissipation at T _c = 25 °C	2		W
T _{stg}	Storage Temperature	-65 to 150		°C
Tj	Max. Operating Junction Temperature	150		°C

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THERMAL DATA

R _{thj-amb} •	Thermal Resistance	Junction-Ambient	Max	62.5	°C/W
R _{thj-tab} ●	Thermal Resistance	Junction-Collecor Tab	Max	8	°C/W

Mounted on a ceramic substrate area = 30 x 35 x 0.7 mm

ELECTRICAL CHARACTERISTICS (T_{case} = 25 °C unless otherwise specified)

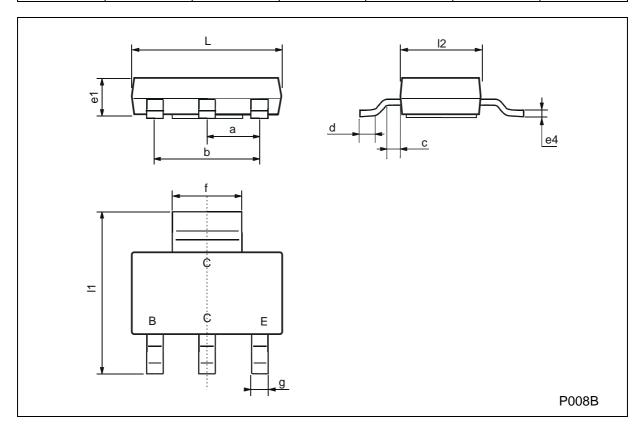
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Ісво	Collector Cut-off Current (I _E = 0)	$V_{CB} = 30 \text{ V}$ $V_{CB} = 30 \text{ V}$ $T_j = 125 ^{\circ}\text{C}$			100 10	nΑ μΑ
V _{(BR)CBO}	Collector-Base Breakdown Voltage (I _E = 0)	I _C = 100 μA for BCP55 for BCP56	60 100			V V
V _{(BR)CEO*}	Collector-Emitter Breakdown Voltage (I _B = 0)	I _C = 20 mA for BCP55 for BCP56	60 80			V V
V _(BR) CER	Collector-Emitter Breakdown Voltage (R _{BE} = 1 KΩ)	I _C = 100 μA for BCP55 for BCP56	60 100			V V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage (I _C = 0)	I _C = 10 μA	5			V
$V_{CE(sat)^*}$	Collector-Emitter Saturation Voltage	I _C = 500 mA I _B = 50 mA			0.5	V
V _{BE(on)} *	Base-Emitter On Voltage	I _C = 500 mA V _{CE} = 2 V			1	V
h _{FE} *	DC Current Gain	$ \begin{array}{llllllllllllllllllllllllllllllllllll$	25 40 63 100 25		100 160 250	
f _T	Transition Frequency	$I_C = 10 \text{ mA}$ $V_{CE} = 5 \text{ V}$ $f = 35 \text{ MHz}$		130		MHz

^{*} Pulsed: Pulse duration = 300 μs, duty cycle ≤ 1.5 %



SOT-223 MECHANICAL DATA

DIM.	mm			mils			
2	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
а	2.27	2.3	2.33	89.4	90.6	91.7	
b	4.57	4.6	4.63	179.9	181.1	182.3	
С	0.2	0.4	0.6	7.9	15.7	23.6	
d	0.63	0.65	0.67	24.8	25.6	26.4	
e1	1.5	1.6	1.7	59.1	63	66.9	
e4			0.32			12.6	
f	2.9	3	3.1	114.2	118.1	122.1	
g	0.67	0.7	0.73	26.4	27.6	28.7	
I1	6.7	7	7.3	263.8	275.6	287.4	
12	3.5	3.5	3.7	137.8	137.8	145.7	
L	6.3	6.5	6.7	248	255.9	263.8	



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